

Title (en)
IMPLANTABLE MEDICAL DEVICE HEADER

Title (de)
KOPF FÜR EINE IMPLANTIERBARE MEDIZINISCHE VORRICHTUNG

Title (fr)
EMBASE DE DISPOSITIF MÉDICAL IMPLANTABLE

Publication
EP 2919854 B1 20170809 (EN)

Application
EP 13786094 A 20131022

Priority
• US 201213676839 A 20121114
• US 2013066084 W 20131022

Abstract (en)
[origin: US2014135882A1] Techniques for forming a header for an implantable medical device via a two-shot molding process are described. The two-shot molding processes may include a first molding step that creates a first-shot assembly and a second molding step that creates a second-shot assembly. The first-shot assembly may be formed to include one or more protrusions configured to interact with a second-shot mold and/or molding material in the second molding step. The second molding step may be configured to overmold the first-shot assembly. The header may include an attachment plate at least partially embedded in molding material and configured to be mechanically coupled to a body of the implantable medical device.

IPC 8 full level
A61N 1/375 (2006.01); **A61N 1/05** (2006.01)

CPC (source: EP US)
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Designated contracting state (EPC)
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DOCDB simple family (publication)
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